

30V N-CHANNEL ENHANCEMENT MODE MOSFET
Product Summary

BV _{DSS}	Max R _{DS(on)} MAX	Max I _D MAX T _A = 25°C
30V	65mΩ @ V _{GS} = 10V	3.2A
	95mΩ @ V _{GS} = 4.5V	2.6A

Description and Applications

This MOSFET is designed to meet the stringent requirements of Automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

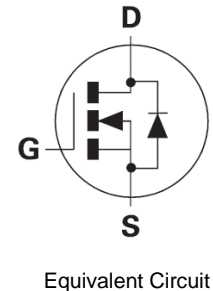
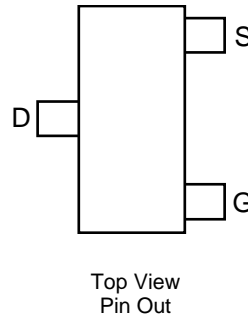
- DC - DC Converters
- Power Management Functions
- Disconnect Switches
- Motor Control

Features and Benefits

- Low on-resistance
- Fast switching speed
- Low gate charge
- Low threshold
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**
- **PPAP Capable (Note 4)**

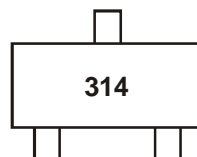
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish —Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (E3)
- Terminals Connections: See Diagram Below
- Weight: 0.009 grams (Approximate)


Ordering Information (Note 5)

Product	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXMN3A14FQTA	314	7	8	3,000 Units

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
 5. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information


314 = Product Type Marking Code

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

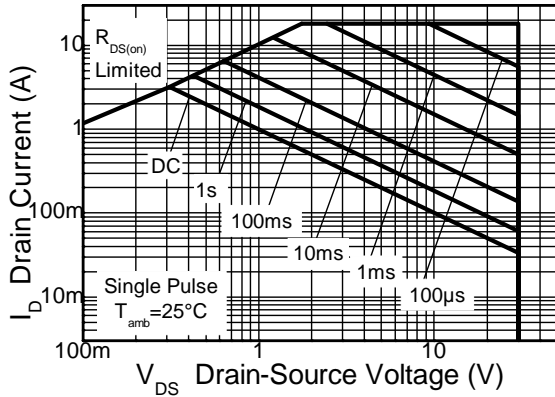
Characteristic			Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	30	V
Gate-Source Voltage			V _{GS}	±20	V
Continuous Drain Current	V _{GS} = 10V	T _A = 70°C	I _D	(Note 7)	3.9
				(Note 7)	3.2
				(Note 6)	3.2
Pulsed Drain Current (Note 8)			I _{DM}	18	A
Continuous Source Current (Body Diode) (Note 7)			I _S	2.3	A
Pulsed Source Current (Body Diode) (Note 8)			I _{SM}	18	A

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

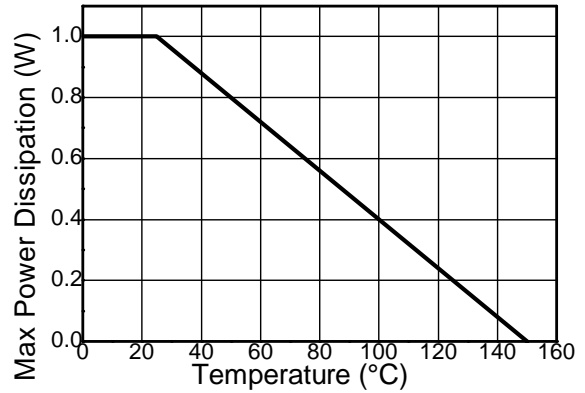
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P _D	1	W
Linear Derating Factor		8	mW/°C
Power Dissipation (Note 7)	P _D	1.5	W
Linear Derating Factor		12	mW/°C
Thermal Resistance, Junction to Ambient (Note 6)	R _{θJA}	125	°C/W
Thermal Resistance, Junction to Ambient (Note 7)	R _{θJA}	83	°C/W
Thermal Resistance, Junction to Leads (Note 9)	R _{θJL}	70.44	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

- Notes:
6. For a device surface mounted on 25mm x 25mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions
 7. For a device surface mounted on FR4 PCB measured at t ≤ 5 secs.
 8. Repetitive rating 25mm x 25mm FR4 PCB, D=0.02 pulse width=300µs - pulse current limited by maximum junction temperature.
 9. Thermal resistance from junction to solder-point (at the end of the drain lead).

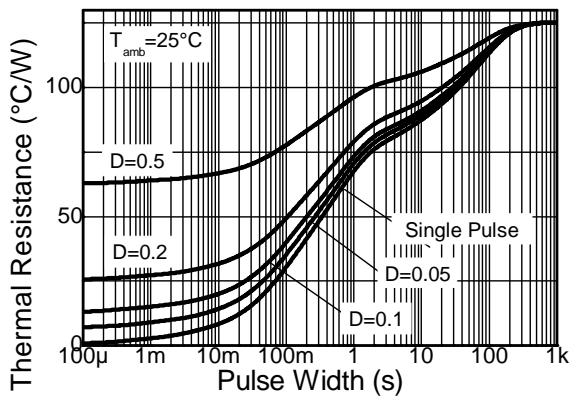
Thermal Characteristics



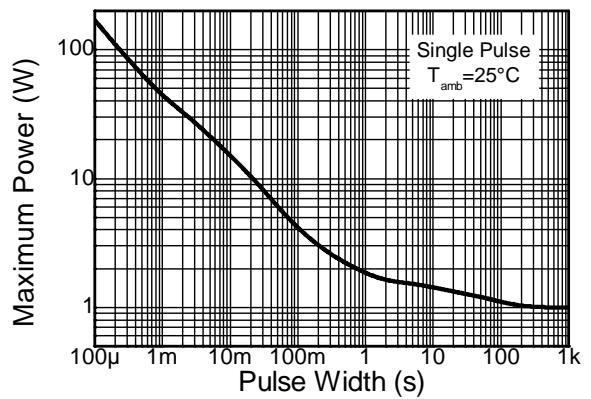
Safe Operating Area



Derating Curve



Transient Thermal Impedance



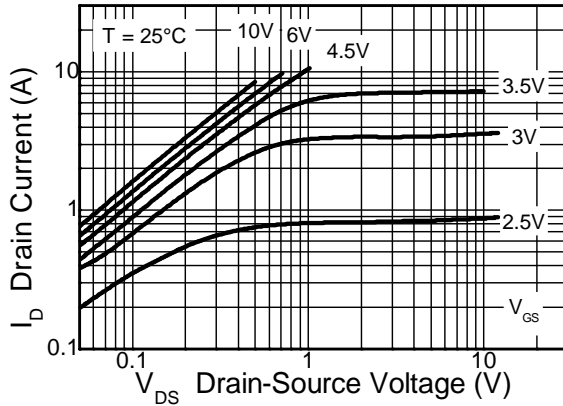
Pulse Power Dissipation

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

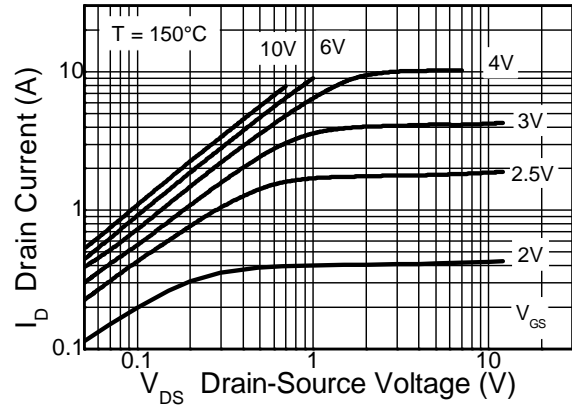
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	30	—	—	V	I _D = 250μA, V _{GS} = 0V
Zero Gate Voltage Drain Current	I _{DSS}	—	—	1	μA	V _{DS} = 30V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	—	—	±100	nA	V _{GS} = ±12V, V _{DS} = 0V
ON CHARACTERISTICS						
Gate Threshold Voltage	V _{GS(th)}	1.0	—	2.2	V	I _D = 250μA, V _{DS} = V _{GS}
Static Drain-Source On-Resistance (Note 10)	R _{DS(on)}	—	48	65	mΩ	V _{GS} = 10V, I _D = 3.2A
			69	95		V _{GS} = 4.5V, I _D = 2.6A
Forward Transconductance (Notes 10 and 12)	g _{fs}	—	7.1	—	S	V _{DS} = 15V, I _D = 3.2A
Diode Forward Voltage (Note 10)	V _{SD}	—	0.85	0.95	V	T _J = 25°C, I _S = 2.5A, V _{GS} = 0V
Reverse Recovery Time (Note 12)	t _{rr}	—	13	—	ns	T _J = 25°C, I _F = 1.6A, di/dt = 100A/μs
Reverse Recovery Charge (Note 12)	Q _{rr}	—	7	—	nC	
DYNAMIC CHARACTERISTICS (Note 12)						
Input Capacitance	C _{iss}	—	448	—	pF	V _{DS} = 15V, V _{GS} = 0V f = 1.0MHz
Output Capacitance	C _{oss}	—	82	—		
Reverse Transfer Capacitance	C _{rss}	—	49	—		
Turn-On Delay Time (Note 11)	t _{D(on)}	—	2.4	—	ns	V _{DD} = 15V, I _D = 1A, R _G ≅ 6.0Ω, V _{GS} = 10V
Turn-On Rise Time (Note 11)	t _r	—	2.5	—		
Turn-Off Delay Time (Note 11)	t _{D(off)}	—	13.1	—		
Turn-Off Fall Time (Note 11)	t _f	—	5.3	—		
Total Gate Charge (Note 11)	Q _g	—	8.6	—	nC	V _{DS} = 15V, V _{GS} = 10V, I _D = 3.2A
Gate-Source Charge (Note 11)	Q _{gs}	—	1.4	—		
Gate-Drain Charge (Note 11)	Q _{gd}	—	1.8	—		

Notes:
 10. Measured under pulsed conditions. Pulse width = 300μs. Duty cycle ≤ 2%.
 11. Switching characteristics are independent of operating junction temperature.
 12. For design aid only, not subject to production testing.

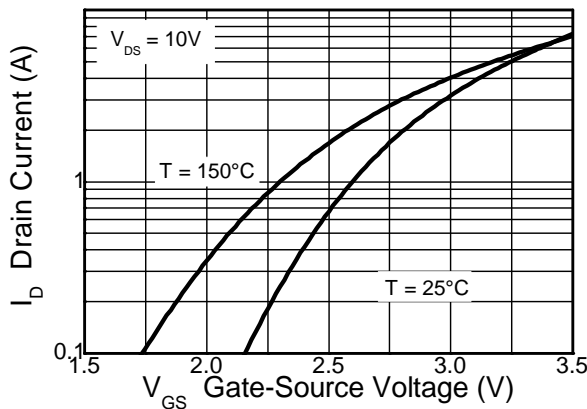
Typical Characteristics



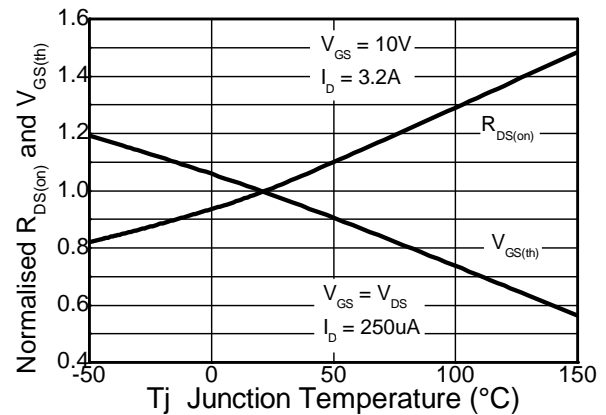
Output Characteristics



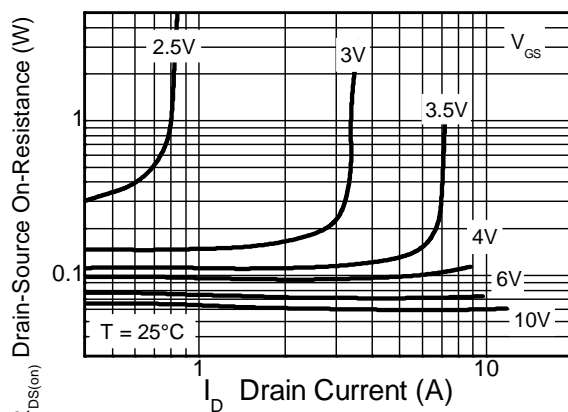
Output Characteristics



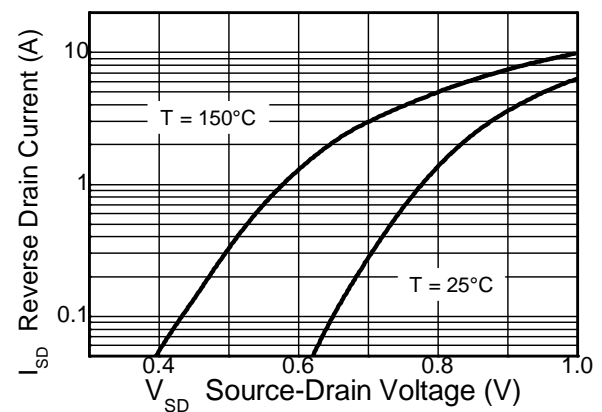
Typical Transfer Characteristics



Normalised Curves v Temperature

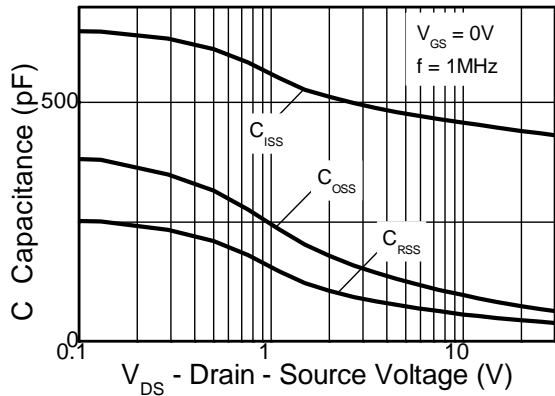


On-Resistance v Drain Current

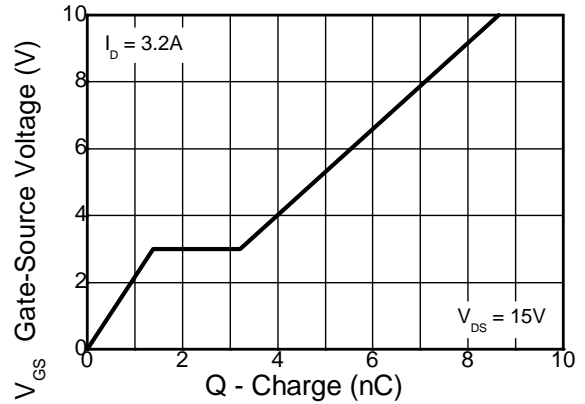


Source-Drain Diode Forward Voltage

Typical Characteristics (continued)

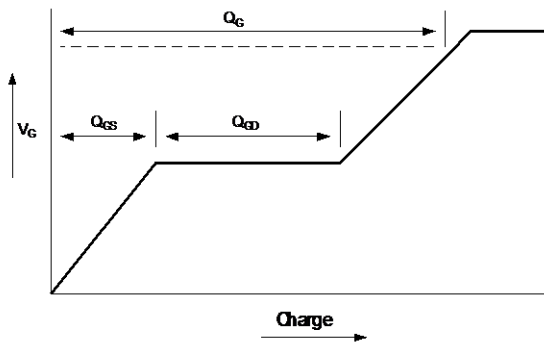


Capacitance v Drain-Source Voltage

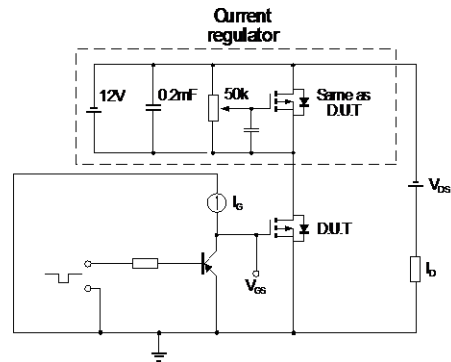


Gate-Source Voltage v Gate Charge

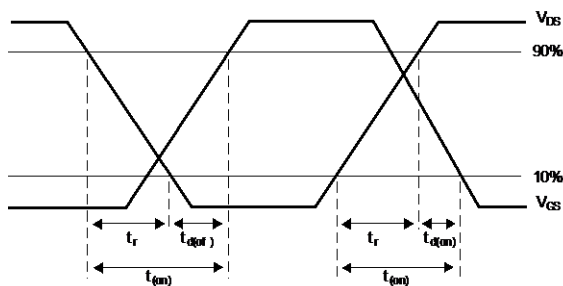
Test Circuits



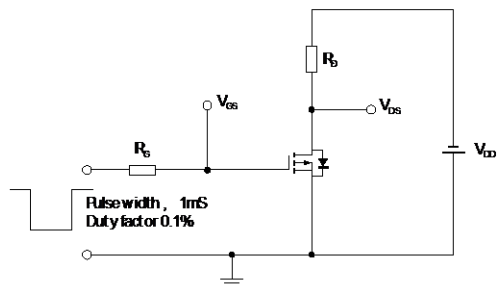
Basic gate charge waveform



Gate charge test circuit



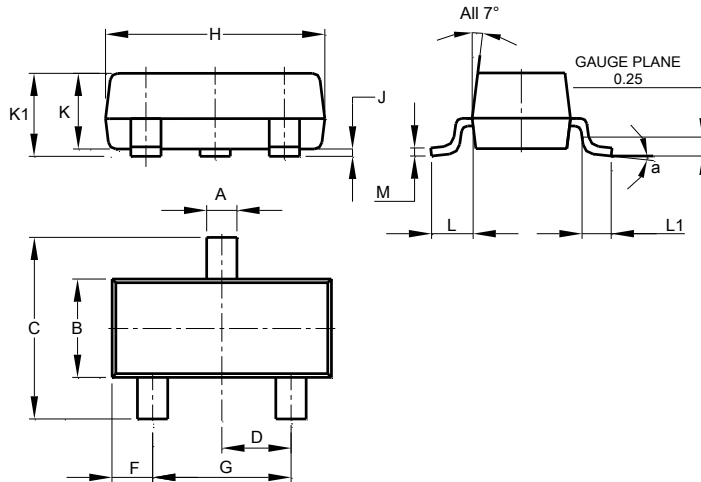
Switching time waveforms



Switching time test circuit

Package Outline Dimensions

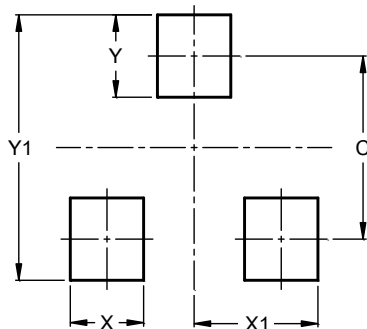
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



SOT23			
Dim	Min	Max	Typ
A	0.37	0.51	0.40
B	1.20	1.40	1.30
C	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
H	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
M	0.085	0.150	0.110
a	0°	8°	--
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	2.0
X	0.8
X1	1.35
Y	0.9
Y1	2.9

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